

RoHS Reach Halogen Free Pb Free

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交货型号	C2012X7R1E335MT****	
用途	一般等级 车载用途时为 <u>CGA4_J1X7R1E335M125AC</u> 。	
特点	General 一般(~75V)	
系列	C2012 [EIA 0805]	
状态	▲ 量产体制(新设计非推荐)	Þ

	尺寸
长度(L)	2.00mm ±0.20mm
宽度(W)	1.25mm ±0.20mm
厚度(T)	1.25mm ±0.20mm
端子宽度(B)	0.20mm Min.
	0.50mm Min.
推荐焊盘布局 (PA)	1.00mm to 1.30mm(Flow Soldering)
推存序盘仰向 (ra)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局 (PC)	0.80mm to 1.10mm(Flow Soldering)
3E477F3m/III/III (I 0)	0.90mm to 1.20mm(Reflow Soldering)

	电气特性	
电容	3.3 μF ±20%	
额定电压	25VDC	
温度特性	X7R(±15%)	
耗散因数 (Max.)	7.5%	
	151MΩ	

	其他
焊接方法	流体
杆按刀伍	回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

 $!\ \mbox{Images}$ are for reference only and show exemplary products.

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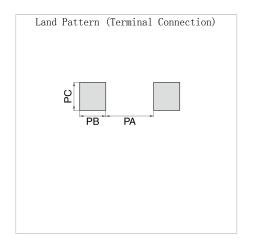
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Associated Images



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